

## Peelable mask

A peelable mask is applied by screen print on cured solder mask. Covers lines, connectors or vias by a soldering process, reflow soldering or HAL. After using in the cover process it can be easily removed with simple peeling without keeping any residues.

Manufacturer	Product name	Using	Specification
PETERS	<u>SD 2955/30</u>	<ul style="list-style-type: none"><li>&gt; protect selected vias against plugging by solder process</li><li>&gt; protect Au contacts or carbon pads by solder process</li><li>&gt; protect selected parts of PCB for surface finish</li></ul>	<ul style="list-style-type: none"><li>&gt; overlap on Cu pattern: min. 1,0 mm</li><li>&gt; distance to pad: min. 1,0 mm</li><li>&gt; finish hole size: max. 2,0 mm</li><li>&gt; peel off pattern width: min. 1,0 mm</li><li>&gt; distance to edge fo PCB: min. 1,0 mm</li></ul>